



Add a jumper to the kit populated on the kit in SV7 on pins 2 and 3

Antenna Coil - 0.5mm trace size - 6 turns
 - Traces on both sides - Trace coil mean is 38mmx20mm

Place capacitors shown around MCU as close as possible to the MCU

SV7 and SV16 should be placed symmetrically next to the Boosterpack headers but not interfering with them

Place Note USB For Power Only

Note: DNP = Do Not Populate

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